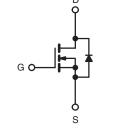




E Series Power MOSFET

PRODUCT SUMMARY				
V _{DS} (V) at T _J max.	650			
R _{DS(on)} max. at 25 °C (Ω)	$V_{GS} = 10 V$	0.125		
Q _g max. (nC)	130			
Q _{gs} (nC)	15			
Q _{gd} (nC)	39			
Configuration	Single			





N-Channel MOSFET

FEATURES

- Low figure-of-merit (FOM) Ron x Qg
- Low input capacitance (C_{iss})
- · Reduced switching and conduction losses
- Ultra low gate charge (Q_q)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
 - LED lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
- Battery chargers
- Renewable energy
 - Solar (PV inverters)

ORDERING INFORMATION				
Package	TO-247AC			
Lead (Pb)-free	SiHG30N60E-E3			
Lead (Pb)-free and Halogen-free	SiHG30N60E-GE3			

ABSOLUTE MAXIMUM RATINGS ($T_C = 25 \degree C$, unless otherwise noted)							
PARAMETER			SYMBOL	LIMIT	UNIT		
Drain-Source Voltage			V _{DS}	600	v		
Gate-Source Voltage			V _{GS}	± 30			
Continuous Drain Current (T _J = 150 °C)	V _{GS} at 10 V	$T_{\rm C} = 25 \ ^{\circ}{\rm C}$ $T_{\rm C} = 100 \ ^{\circ}{\rm C}$	- I _D	29			
	V _{GS} at 10 V	T _C = 100 °C		18	А		
Pulsed Drain Current ^a			I _{DM}	65			
Linear Derating Factor				2	W/°C		
Single Pulse Avalanche Energy ^b			E _{AS}	690	mJ		
Maximum Power Dissipation			PD	250	W		
Operating Junction and Storage Temperature Range			T _J , T _{stg}	-55 to +150	°C		
Drain-Source Voltage Slope	$V_{DS} = 0 V \text{ to } 80 \% V_{DS}$		d)//dt	70			
Reverse Diode dV/dt ^d		dV/dt	18	V/ns			
Soldering Recommendations (Peak Temperature) ^c	for 10 s			300	°C		

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature.

b. V_{DD} = 50 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 Ω , I_{AS} = 7 A.

c. 1.6 mm from case.

d. $I_{SD} \leq I_D, \, dI/dt$ = 100 A/µs, starting T_J = 25 °C.

1 For technical questions, contact: <u>hvm@vishay.com</u>



COMPLIANT

HALOGEN



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THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	R _{thJA}	-	62	°C/W	
Maximum Junction-to-Case (Drain)	R _{thJC}	-	0.5	0/10	

PARAMETER	SYMBOL	TES	MIN.	TYP.	MAX.	UNIT	
Static					•		
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 V, I_D = 250 \mu A$		600	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference to 25 °C, $I_D = 250 \ \mu A$		-	0.64	-	V/°C
Gate-Source Threshold Voltage (N)	V _{GS(th)}	V _{DS} =	- V _{GS} , I _D = 250 μΑ	2.0	2.8	4.0	V
	I _{GSS}	$V_{GS} = \pm 20 V$		-	-	± 100	nA
Gate-Source Leakage			V _{GS} = ± 30 V	-	-	± 1	μA
Zara Cata Valtaga Drain Current		V _{DS} =	= 600 V, V _{GS} = 0 V	-	-	1	
Zero Gate Voltage Drain Current	IDSS	V _{DS} = 600 V	-	-	100	μA	
Drain-Source On-State Resistance	R _{DS(on)}	$V_{GS} = 10 V$	I _D = 15 A	-	0.104	0.125	Ω
Forward Transconductance ^a	9 _{fs}	V _D s	_S = 8 V, I _D = 3 A	-	5.4	-	S
Dynamic				•	•	•	•
Input Capacitance	C _{iss}	$V_{GS} = 0 V,$ $V_{DS} = 100 V,$ f = 1.0 MHz		-	2600	-	pF
Output Capacitance	C _{oss}			-	138	-	
Reverse Transfer Capacitance	C _{rss}			-	3	-	
Effective Output Capacitance, Energy Related ^a	C _{o(er)}	$V_{\rm DS}$ = 0 V to 480 V, $V_{\rm GS}$ = 0 V		-	98	-	
Effective Output Capacitance, Time Related ^b	C _{o(tr)}			-	346	-	
Total Gate Charge	Qg		V _{GS} = 10 V I _D = 15 A, V _{DS} = 480 V	-	85	130	
Gate-Source Charge	Q _{gs}	V _{GS} = 10 V		-	15	-	nC
Gate-Drain Charge	Q _{gd}	1 1		-	39	-	-
Turn-On Delay Time	t _{d(on)}			-	19	40	
Rise Time	t _r	V _{DD} =	V_{DD} = 380 V, I_D = 15 A, V_{GS} = 10 V, R_g = 4.7 Ω		32	65	ns
Turn-Off Delay Time	t _{d(off)}	V _{GS} =			63	95	
Fall Time	t _f				36	75	
Gate Input Resistance	Rg	f = 1 MHz, open drain		-	0.63	-	Ω
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I _S	showing	MOSFET symbol showing the		-	29	
Pulsed Diode Forward Current	I _{SM}	p - n junction diode		-	-	65	A
Diode Forward Voltage	V _{SD}	$T_{J} = 25 \text{ °C}, I_{S} = 15 \text{ A}, V_{GS} = 0 \text{ V}$		-	-	1.3	V
Body Diode Reverse Recovery Time	t _{rr}			-	402	605	ns
Body Diode Reverse Recovery Charge	Q _{rr}	$T_J = 25 \ ^{\circ}C, I_F = I_S = 15 \ A,$ dl/dt = 100 A/µs ^{, V} _R = 20 V		-	7	15	μC
Reverse Recovery Current	I _{RBM}			-	32	65	Α

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .

b. C_{oss(tr)} is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}.



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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

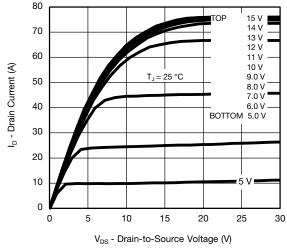
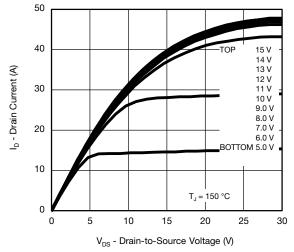
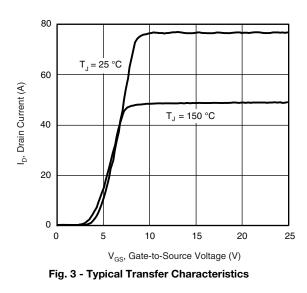


Fig. 1 - Typical Output Characteristics, T_C = 25 °C







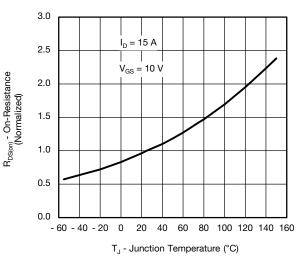


Fig. 4 - Normalized On-Resistance vs. Temperature

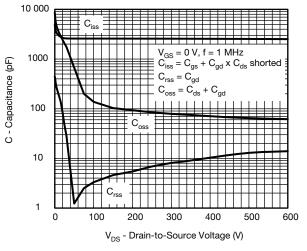
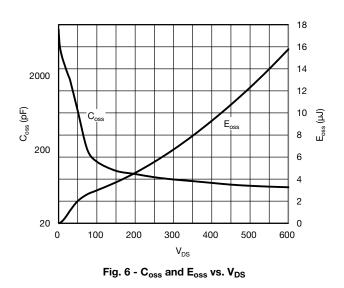


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage



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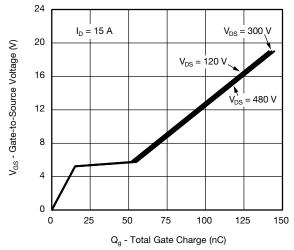


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

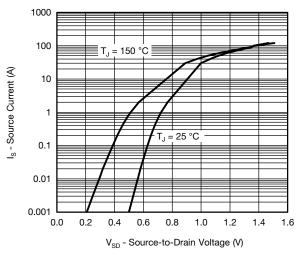


Fig. 8 - Typical Source-Drain Diode Forward Voltage

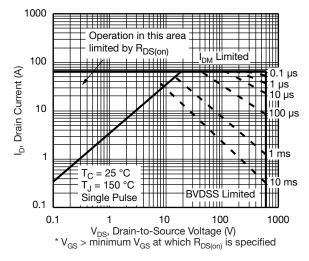


Fig. 9 - Maximum Safe Operating Area

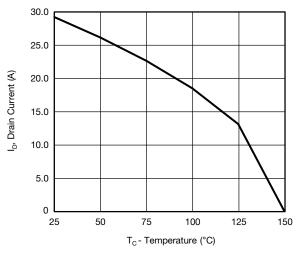


Fig. 10 - Maximum Drain Current vs. Case Temperature

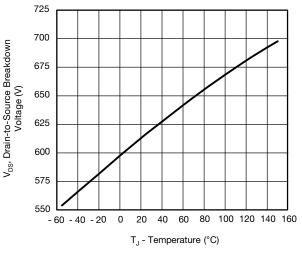
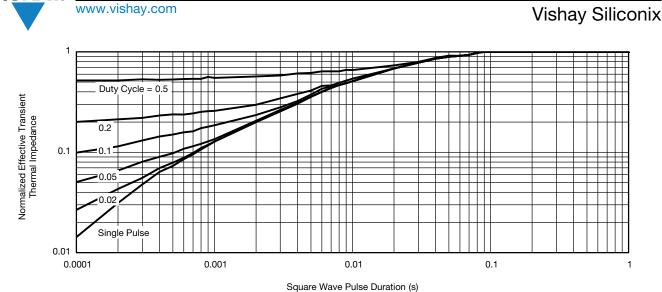


Fig. 11 - Temperature vs. Drain-to-Source Voltage

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Square Wave Pulse Duration (s) Fig. 12 - Normalized Thermal Transient Impedance, Junction-to-Case

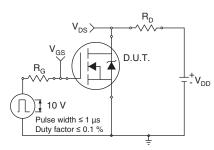


Fig. 13 - Switching Time Test Circuit

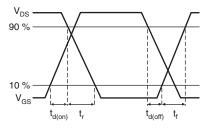


Fig. 14 - Switching Time Waveforms

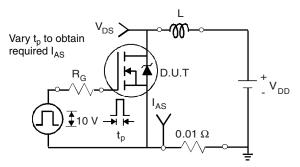


Fig. 15 - Unclamped Inductive Test Circuit

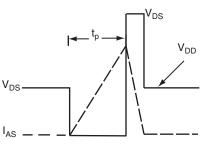


Fig. 16 - Unclamped Inductive Waveforms

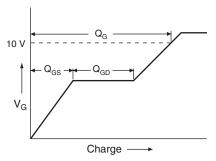


Fig. 17 - Basic Gate Charge Waveform

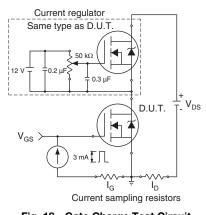


Fig. 18 - Gate Charge Test Circuit

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Peak Diode Recovery dV/dt Test Circuit

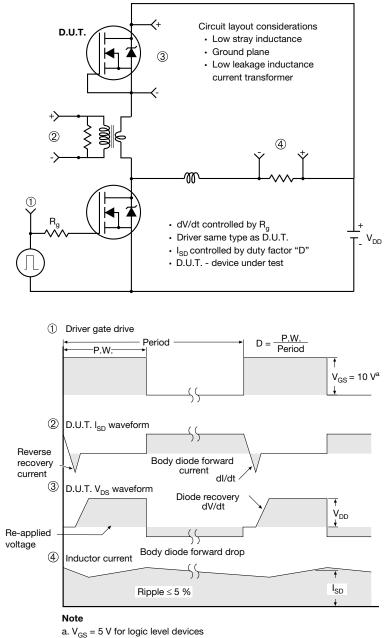


Fig. 19 - For N-Channel

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TO-247AC (High Voltage)

ECN: X13-0103-Rev. D, 01-Jul-13 DWG: 5971

Notes

1. Dimensioning and tolerancing per ASME Y14.5M-1994.

2. Contour of slot optional.

 Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body.

4. Thermal pad contour optional with dimensions D1 and E1.

5. Lead finish uncontrolled in L1.

6. Ø P to have a maximum draft angle of 1.5 to the top of the part with a maximum hole diameter of 3.91 mm (0.154").

7. Outline conforms to JEDEC outline TO-247 with exception of dimension c.

8. Xian and Mingxin actually photo.





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